

EECE

Search Query Display

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10. (thin*) chip circuit* rigid) AND PN((<4/4/1997)	4 results	
9. (thin*) chip circuit* rigid) AND PN((<4/4/1997)	1215 results	
8. (thin*) chip circuit* rigid) AND PN((<4/4/1997)	4 results	
7. (thin*) wafer circuit* rigid) AND PN((<4/4/1997)	0 result	
6. (thin wafer circuit* rigid) AND PN((<4/4/1997)	0 result	
5. (thin substrate circuit* rigid) AND PN((<4/4/1997)	5 results	
4. (thin substrate circuit* rigid) AND PN((<4/4/1997)	5 results	
3. (thin substrate circuit* rigid) AND PN((<4/4/1997)	366 results	
2. (thin substrate circuit* rigid) AND PN((<4/4/1997)	5 results	
1. (thin substrate circuit* rigid) AND PN((<4/4/1997)	366 results	

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Recent Searches

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#	Ref	Hits	Search Query	DBs	Default	Plurals	Time Stamp
				Operato	s	x	
S1	2	"20040070063"	US-PGPUB	OR	OFF		2008/10/01 15:47
S2	89	(glenin near2 Leedy) .in.	US-PGPUB	OR	OFF		2008/10/01 11:25
S3	24	(glenin near2 Leedy) .in.	US-PGPUB	OR	OFF		2008/10/01 11:42
S4	22	(glenin near2 Leedy) .in.	US-PGPUB	OR	OFF		2008/10/01 11:41
S5	0	(glenin near2 Leedy) .in.	US-PGPUB	OR	OFF		2008/10/01 11:29
S6	0	(glenin near2 Leedy) .in.	US-PGPUB	OR	OFF		2008/10/01 11:29
S7	0	(glenin near2 Leedy) .in.	US-PGPUB	OR	OFF		2008/10/01 11:33

## FAST Search History

CASE# 10/672,961

S8	4	(g)lenin near2 LeeDy).in. and (second near3 thIn\$4 near3 substracte\$2 near3 circuit\$4)	US-PGPUB ; USPAT; USOCR; EPRs; EPO; JPO; DEPARTMENT;	OR OFF	2008/10/01 11:42	44	(“4070230”   “4131985”   “4416054”   “4539068”   “4585991”   “4612083”   “4617160”   “4618397”   “4618763”   “4702936”   “4706166”   “4721938”   “4761681”   “4784721”   “5262351”   “5236118”   “5130894”   “5273940”   “5324687”   “5284796”   “5656552”   “5675185”   “5581498”   “5537536”   “5534465”   “5563084”   “5489554”   “5502667”   “5424920”   “5426072”   “5432729”   “5457879”   “5694588”   “5760478”   “5793115”   “5880010”   “5902118”   “6194245”   “6208545”   “6236602”   “6208545”   “6236602”   PN.	OR ON	2008/10/01 13:45	S10
S11	61443	(U11-C02F or U11-F01 or U11-E02B3 or U11-F01 or U11-G02 or U12-C02 or U12-C04 or U13-B01 or U13-B02 or U13-C02 or U13-D01 or U13-D02 or U13-D03B or U13-E02 or U13-E04 or T01-J152 or S01-G01)	EPO; JPO; DEPARTMENT;	OR ON	2008/10/01 12:07	S11				
S12	4425	(thIn\$4 or slIm\$3 or thick) near3 (wafer\$2 or substracte\$2 or chip\$2 or microchip\$2 or die or dates or die\$3) near5	EPO; JPO; DEPARTMENT;	OR ON	2008/10/01 13:46	S12				
S13	79	(second\$4 or other) near5 (thIn\$4 or slIm\$3 or thick) near3 (wafer\$2 or substracte\$2 or chip\$2 or microchip\$2 or die or dates or die\$3) near5	EPO; JPO; DEPARTMENT;	OR ON	2008/10/01 13:46	S13				

## EAST Search History

S14	24408	(rigid\$4 or rough or hard or firm or inflexible or unbendable or stiff or (fine adj grainless)) near\$5 (wafer\$2 or substrate\$2 or chip\$2 or microchip\$2 or die or dies or dice\$3) near\$5 ("same" or equal or exact) near\$5 (Length or dimensions or size\$2 or width) near\$5 measuring or semirigid or tensile\$2 or tensile\$2 or unbendable or stiff or rigid\$4 or rough or hard or firm or inflexible or unbendable or stiff or (fine adj grainless)) near\$5 (wafer\$2 or substrate\$2 or chip\$2 or microchip\$2 or die or dies or dice\$3)	EPO; JPO;	OR	ON	2008/10/01 13:47	
S15	4930	(wafer\$2 or substrate\$2 or chip\$2 or microchip\$2 or die or dies or dice\$3) near\$5 ("same" or equal or exact) near\$5 (Length or dimensions or size\$2 or width) near\$5 measuring or semirigid or tensile\$2 or tensile\$2 or unbendable or stiff or rigid\$4 or rough or hard or firm or inflexible or unbendable or stiff or (fine adj grainless)) near\$5 (wafer\$2 or substrate\$2 or chip\$2 or microchip\$2 or die or dies or dice\$3)	EPO; JPO;	OR	ON	2008/10/01 13:47	
S16	2088190	(S10 or S11) S16 and S13 and S14 and S16 and S12 and S14 and S16 and S12 and S13 EPO; JPO;	EPO; JPO;	OR	ON	2008/10/01 12:12	
S17	0	S16 and S13 and S14 and S16 and S12 and S13 EPO; JPO;	EPO; JPO;	OR	ON	2008/10/01 12:13	
S18	0	S16 and S12 and S14 and S15 EPO; JPO;	EPO; JPO;	OR	ON	2008/10/01 12:13	
S19	2210	S16 and S12 EPO; JPO;	EPO; JPO;	OR	ON	2008/10/01 12:13	
S20	49	S16 and S13 EPO; JPO;	EPO; JPO;	OR	ON	2008/10/01 12:14	
S21	10	S16 and S14 and S15 EPO; JPO;	EPO; JPO;	OR	ON	2008/10/01 12:25	
S22	0	S20 and S21 EPO; JPO;	EPO; JPO;	OR	ON	2008/10/01 12:15	
S23	0	S13 and S14 and S15 EPO; JPO;	EPO; JPO;	OR	ON	2008/10/01 12:25	
S24	1	S13 and S14 EPO; JPO;	EPO; JPO;	OR	ON	2008/10/01 12:25	
S25	0	S13 and S15 EPO; JPO;	EPO; JPO;	OR	ON	2008/10/01 12:25	

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S26	61	S14 and S15	EPO; JPO; DERMENIT; IBM TDB	OR	ON	2008/10/01	12:26	
S27	51	S26 note S21	EPO; JPO; DERMENIT; IBM TDB	OR	ON	2008/10/01	12:26	
S28	1991809	(IC or (integrated adj circuit\$4) or memory or chips or DRAM or ram or flash or eeprom or ferroelectric or sram or gmr)	US-PGGB	OR	ON	2008/10/01	13:45	
S29	11728	(thins\$4 or slims\$3 or substract\$2 or chipes\$2 or wafers\$2 or slims\$3 or thick) near5 (wafers\$2 or substract\$2 or chipes\$2 or date or circuit\$4)	US-PGGB	OR	ON	2008/10/01	13:46	
S30	562	(second\$4 or other) near5 (thins\$4 or slims\$3 or substract\$2 or chipes\$2 or thick) near5 (wafers\$2 or substract\$2 or chipes\$2 or date or circuit\$4)	US-PGGB	OR	ON	2008/10/01	13:46	
S31	74642	(rigid\$4 or rough or hard or firm or inflexible or unbending or stiff or tenses\$2 or semirigid or near5 ("grain\$4)) near5 (fine adj grain\$4) near5 (near5 ("same" or equal or exact) near5 ("near5 (length or width) measurement or width))	US-PGGB	OR	ON	2008/10/01	13:47	
S32	30644	(wafer\$2 or substract\$2 or chipes\$2 or microchips\$2 or date or dates or die\$3) near5 (near5 ("same" or equal or exact) near5 ("near5 (length or width) measurement or width))	US-PGGB	OR	ON	2008/10/01	14:24	
S33	15	S28 and S29 and S30 and S31 and S32	US-PGGB	OR	ON	2008/10/01	13:59	
S34	465	S28 and S30	US-PGGB	OR	ON	2008/10/01	13:59	
S35	15	S30 and S31 and S32	US-PGGB	OR	ON	2008/10/01	13:59	
S36	0	S35 note S33	US-PGGB	OR	ON	2008/10/01	14:00	
S37	244	S29 and S31 and S32	US-PGGB	OR	ON	2008/10/01	14:00	
S38	0	S29 with S31 with S32	US-PGGB	OR	ON	2008/10/01	14:23	
S39	122	S31 with S32	US-PGGB	OR	ON	2008/10/01	14:24	

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556	8	S55 note S554	EPO; JPO; IBM_TDB; DERNENT;	OR	OFF	2008/10/01 16:26	
557	7	(S48 near2 S49 near2 S50) and S51 and ("1980" or "1981" or "1982" or "1983" or "1984" or "1985" or "1986" or "1987" or "1988" or "1989") .PY.	EPO; JPO; IBM_TDB; DERNENT;	OR	OFF	2008/10/01 16:29	
558	47	(S48 near4 S49 near4 S50) and S51 and ("1990" or "1991" or "1992" or "1993" or "1994" or "1995" or "1996" or "1997") .PY.	EPO; JPO; IBM_TDB; DERNENT;	OR	OFF	2008/10/01 16:31	
559	32	S58 note (S55 or S54)	EPO; JPO; IBM_TDB; DERNENT;	OR	OFF	2008/10/01 16:31	

**EAST Search History**